





#### **DUAL SURFACE MOUNT SWITCHING DIODE**

#### **Features**

- Fast Switching Speed
- Surface Mount Package Ideally Suited for Automated Insertion
- For General Purpose Switching Applications
- High Conductance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Notes 3 & 4)
- Qualified to AEC-Q101 Standards for High Reliability

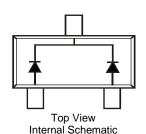
### **Mechanical Data**

- Case: SOT23
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208<sup>3</sup>
- · Polarity: See Diagram
- Weight: 0.008 grams (Approximate)









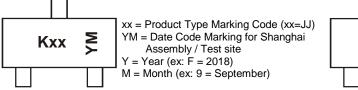
### **Ordering Information** (Note 5)

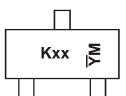
| Part Number | Compliance | Case  | Packaging          |
|-------------|------------|-------|--------------------|
| BAV70-7-F   | Standard   | SOT23 | 3000/Tape & Reel   |
| BAV70-13-F  | Standard   | SOT23 | 10,000/Tape & Reel |
| BAV70Q-7-F  | Automotive | SOT23 | 3000/Tape & Reel   |
| BAV70Q-13-F | Automotive | SOT23 | 10,000/Tape & Reel |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Products manufactured with Date Code 9W (week 39, 2009) and newer are built with Green Molding Compound. Products manufactured prior to Date Code 9W are built with Non-Green Molding Compound and may contain Halogens or Sb<sub>2</sub>O<sub>3</sub> Fire Retardants.
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

### **Marking Information**





 $\begin{array}{l} xx = \text{Product Type Marking Code } (xx = \text{JJ}) \\ \overline{Y}M = \text{Date Code Marking for Chengdu} \\ \text{Assembly / Test site} \\ \overline{Y} = \text{Year } (\text{ex: F} = 2018) \\ \end{array}$ 

M = Month (ex: 9 = September)

Date Code Key

| Date Code Rey |      |      |     |      |      |      |      |     |       |        |      |      |      |
|---------------|------|------|-----|------|------|------|------|-----|-------|--------|------|------|------|
| Year          | 2000 | 2001 |     | 2013 | 2014 | 2015 | 2016 | 201 | 7 201 | 8 2019 | 2020 | 2021 | 2022 |
| Code          | L    | М    |     | Α    | В    | С    | D    | Е   | F     | G      | Н    | I    | J    |
| Month         | Jan  | Feb  | Mar | Apr  | Ма   | ıy J | un   | Jul | Aug   | Sep    | Oct  | Nov  | Dec  |
| Code          | 1    | 2    | 3   | 4    | 5    |      | 6    | 7   | 8     | 9      | 0    | N    | D    |



# 

| Characteristic   |                           | Symbol   | Value      | Unit |
|--|---------------------------|--|------------|------|
| Non-Repetitive Peak Reverse Voltage  |                           | $V_{RM}$   | 100        | V    |
| Peak Repetitive Reverse Voltage<br>Working Peak Reverse Voltage<br>DC Blocking Voltage |                           | V <sub>RRM</sub><br>V <sub>RWM</sub><br>V <sub>R</sub> | 75         | V    |
| RMS Reverse Voltage  |                           | V <sub>R(RMS)</sub>                                    | 53         | V    |
| Forward Continuous Current (Note 6)  |                           | I <sub>FM</sub>  | 300        | mA   |
| Average Rectified Output Current (Note 6)  |                           | lo   | 150        | mA   |
| Repetitive Peak Forward Current  |                           | I <sub>FRM</sub>                                       | 450        | mA   |
| Non-Repetitive Peak Forward Surge Current  | @ t = 1.0µs<br>@ t = 1.0s | I <sub>FSM</sub>                                       | 2.0<br>1.0 | А    |

### **Thermal Characteristics**

| Characteristic                                      | Symbol          | Value       | Unit |
|---|-----------------|-------------|------|
| Power Dissipation (Note 6)                          | P <sub>D</sub>  | 350         | mW   |
| Thermal Resistance Junction to Ambient Air (Note 6) | $R_{\theta JA}$ | 357         | °C/W |
| Operating and Storage Temperature Range             | $T_J,T_STG$     | -65 to +150 | °C   |

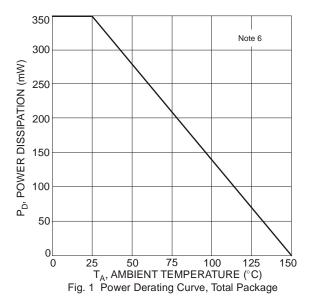
# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

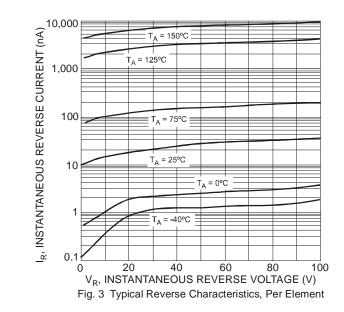
| Characteristic                     | Symbol          | Min | Max                           | Unit | Test Condition   |
|------------------------------------|-----------------|-----|-------------------------------|------|--|
| Reverse Breakdown Voltage (Note 7) | $V_{(BR)R}$     | 75  | _                             | >    | $I_R = 2.5 \mu A$  |
| Forward Voltage                    | VF              |     | 0.715<br>0.855<br>1.0<br>1.25 | ٧    | I <sub>F</sub> = 1.0mA<br>I <sub>F</sub> = 10mA<br>I <sub>F</sub> = 50mA<br>I <sub>F</sub> = 150mA |
| Reverse Current (Note 7)           | I <sub>R</sub>  | _   | 2.5<br>50<br>30<br>25         | μA   | $V_R = 75V$<br>$V_R = 75V$ , $T_J = +150$ °C<br>$V_R = 25V$ , $T_J = +150$ °C<br>$V_R = 20V$       |
| Total Capacitance                  | Ст              | _   | 2.0                           | pF   | V <sub>R</sub> = 0, f = 1.0MHz   |
| Reverse Recovery Time              | t <sub>rr</sub> | _   | 4.0                           | ns   | $I_F = I_R = 10 \text{mA},$<br>$I_{rr} = 0.1 \times I_R, R_L = 100 \Omega$                         |

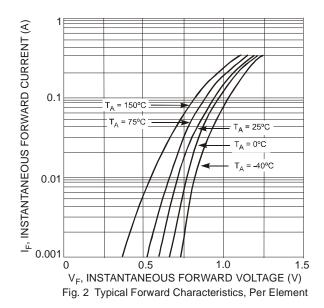
Notes:

- 6. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at http://www.diodes.com.
- 7. Short duration pulse test used to minimize self-heating effect.









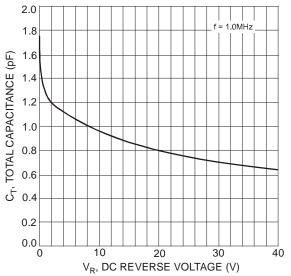
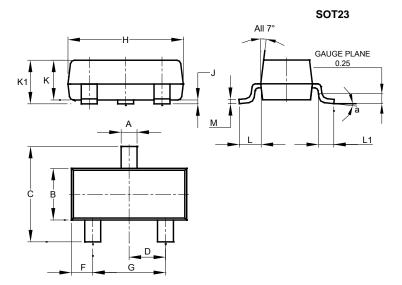


Fig. 4 Total Capacitance vs. Reverse Voltage, Per Element



# **Package Outline Dimensions**

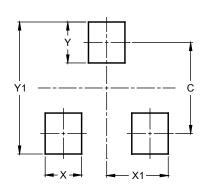
Please see http://www.diodes.com/package-outlines.html for the latest version.



| SOT23                |       |       |       |  |  |  |
|----------------------|-------|-------|-------|--|--|--|
| Dim                  | Min   | Max   | Тур   |  |  |  |
| Α                    | 0.37  | 0.51  | 0.40  |  |  |  |
| В                    | 1.20  | 1.40  | 1.30  |  |  |  |
| С                    | 2.30  | 2.50  | 2.40  |  |  |  |
| D                    | 0.89  | 1.03  | 0.915 |  |  |  |
| F                    | 0.45  | 0.60  | 0.535 |  |  |  |
| G                    | 1.78  | 2.05  | 1.83  |  |  |  |
| Н                    | 2.80  | 3.00  | 2.90  |  |  |  |
| J                    | 0.013 | 0.10  | 0.05  |  |  |  |
| K                    | 0.890 | 1.00  | 0.975 |  |  |  |
| <b>K</b> 1           | 0.903 | 1.10  | 1.025 |  |  |  |
| L                    | 0.45  | 0.61  | 0.55  |  |  |  |
| L1                   | 0.25  | 0.55  | 0.40  |  |  |  |
| М                    | 0.085 | 0.150 | 0.110 |  |  |  |
| а                    | 0°    | 8°    |       |  |  |  |
| All Dimensions in mm |       |       |       |  |  |  |

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



### SOT23

| Dimensions | Value (in mm) |
|------------|---------------|
| C          | 2.0           |
| Х          | 0.8           |
| X1         | 1.35          |
| Υ          | 0.9           |
| Y1         | 2.9           |



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